

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	SECURITY AGREEMENT
CONVEYING PARTY DATA	
Name	Execution Date
Edco Group, Inc.	05/13/2013
RECEIVING PARTY DATA	
Name:	The PrivateBank and Trust Company
Street Address:	70 W. Madison, Suite 200
City:	Chicago
State/Country:	ILLINOIS
Postal Code:	60602
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	11544829
CORRESPONDENCE DATA	
Fax Number:	3146127874
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	314-444-7600
Email:	tbranson@lewisrice.com
Correspondent Name:	Terri Branson
Address Line 1:	600 Washington Ave., Suite 2500
Address Line 2:	Lewis, Rice & Fingersh, L.C.
Address Line 4:	St. Louis, MISSOURI 63101
ATTORNEY DOCKET NUMBER:	109665.57677
NAME OF SUBMITTER:	Terri Branson
Signature:	/Terri Branson/
Date:	05/13/2013
Total Attachments: 5	

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PATENT SECURITY AGREEMENT

THIS PATENT SECURITY AGREEMENT (this "Agreement"), is dated as of May 13, 2013, and is by Edco Group, Inc., a Missouri corporation ("Grantor"), in favor of The PrivateBank and Trust Company ("Lender").

Recitals

A. Grantor, Solcom, Inc., and Lender have entered into a Loan and Security Agreement dated as of the date hereof (as amended, restated, supplemented or otherwise modified from time to time, the "Loan Agreement"), pursuant to which Lender has agreed to make loans to Grantor and issue letters of credit on behalf of Grantor.

B. Pursuant to the Loan Agreement, Grantor is required to execute and deliver to Lender this Agreement.

C. Pursuant to the terms of the Loan Agreement, Grantor has granted to Lender a security interest in substantially all the assets of Grantor, including all right, title and interest of Grantor in, to, and under all now owned and hereafter acquired patents, patent applications and patent licenses, and all products and proceeds thereof (other than any of the foregoing constituting Excluded Property), to secure the payment and performance of the Obligations.

Agreement

In consideration of the mutual agreements set forth herein and in the Loan Agreement, Grantor does hereby grant to Lender, a continuing security interest and lien in all of Grantor's right, title and interest in, to and under the following, whether presently existing or hereafter created or acquired (other than any of the following constituting Excluded Property) to secure the payment and performance of the Obligations:

- (1) each patent and patent application, including, without limitation, each patent and patent application referred to in Schedule 1, together with any reissues, continuations or extensions thereof and all goodwill associated therewith;
- (2) each patent license, including, without limitation, each patent license listed on Schedule 1, together with all goodwill associated therewith; and
- (3) all products and proceeds of the foregoing, including, without limitation, any claim by Grantor against third parties for past, present or future infringement of any patent, including, without limitation, any patent referred to in Schedule 1, any patent issued pursuant to a patent application referred to in Schedule 1 and any patent licensed under any patent license listed on Schedule 1 (items 1 through 3 being herein collectively referred to as the "Patent Collateral").

This security interest and lien is granted in conjunction with the security interests and liens granted to Lender pursuant to the Loan Agreement and subject to limitations set forth therein.

Grantor hereby acknowledges and affirms that the rights and remedies of Lender with respect to the security interests and liens in the Patent Collateral made and granted hereby are more fully set forth in the Loan Agreement, the terms and provisions of which are incorporated by reference herein as if fully set forth herein. Capitalized terms used but not defined herein have the respective meanings ascribed thereto in the Loan Agreement. This Agreement is made under and shall be governed by the internal laws of the State of Illinois applicable to contracts made and to be performed entirely within such state, without regarding to conflict of laws principles thereunder.

[signature page follows]

Grantor has caused this Patent Security Agreement to be duly executed by its duly authorized officer thereunto as of the date first set forth above.

Edco Group, Inc., a Missouri corporation

By: Bill Glassman
Print Name: BILL GLASSMAN
Title: PRESIDENT

Acknowledged:

The PrivateBank and Trust Company

By: _____
Print Name: Edward Dehner
Title: Managing Director

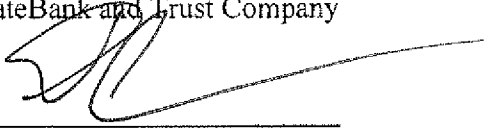
Grantor has caused this Patent Security Agreement to be duly executed by its duly authorized officer thereunto as of the date first set forth above.

Edco Group, Inc., a Missouri corporation

By: _____
Print Name: _____
Title: _____

Acknowledged:

The PrivateBank and Trust Company

By:  _____
Print Name: Edward Dehner
Title: Managing Director

SCHEDULE 1
to
PATENT SECURITY AGREEMENT

Patents, Patent Applications and Patent Licenses

Issued Patents

None.

Patent Licenses

None.

Pending Patent Applications

Abbreviated Title	Application No.	Filing Date	Country
Intelligent medical chart capture system	11/544,829	October 6, 2006	United States